

## TSG-AC Correspondence

Dr. Edward G. Tiedemann, Jr.  
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Mr. Tomas Frankkila  
Contact for E2EMTSI-S4  
3GPP TSG SA WG4  
[Tomas.Frankkila@ericsson.com](mailto:Tomas.Frankkila@ericsson.com)

### **RE: TSG-AC response to LS on End-to-end fixed-mobile interworking**

Dear Mr. Frankkila:

3GPP2 would like to thank 3GPP TSG SA WG4 for your request to review the CR for End-to-end fixed-mobile interworking. TSG-AC and TSG-SX have reviewed the material provided and would like to inform you that 3GPP2 has no comments.

3GPP2 looks forward to further cooperation with 3GPP TSG SA WG4 in the future.

Regards,



Edward G. Tiedemann, Jr.  
Chair, 3GPP2 TSG-AC

cc:	Ms. Jane Brownley	3GPP2 Steering Committee Chair	<a href="mailto:sc_chair@3gpp2.org">sc_chair@3gpp2.org</a>
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